

"SCREENING OF A PRINTED-CIRCUIT ELECTRONICS CARD
MOUNTED ON A METAL SUBSTRATE"

ABSTRACT

The invention proposes an assembly including a printed-circuit electronics card (2) mounted on a metal substrate (1), as well as a metal screening cover (3) electrically connected to the substrate (1). The substrate (1) exhibits a recessed gutter (4) in which the edge of the cover (3) is accommodated. The said edge is crimped onto the said substrate (1) in the gutter (4).

The invention also proposes a method of producing such an assembly.

Figure 1

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ABSTRACT OF THE DISCLOSURE

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circuit electronics card mounted on a metal substrate, as well
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